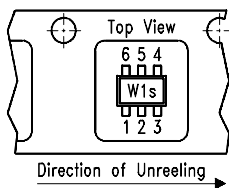


Silicon Switching Diode Array

- For high-speed switching applications
- Internal (galvanic) isolated Diodes in one package

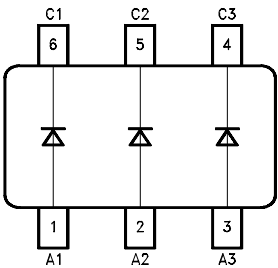
Tape loading orientation



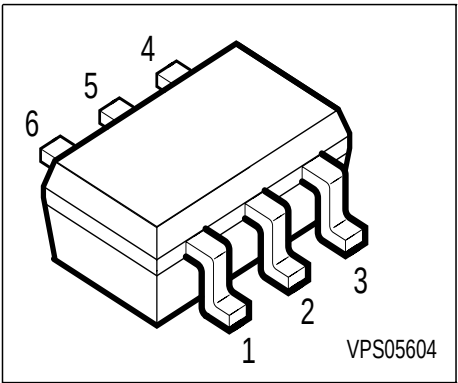
Marking on SOT-363 package
(for example W1s)
corresponds to pin 1 of device

Position in tape: pin 1
opposite of feed hole side

EHA07193



EHA07291



Type	Marking	Ordering Code	Pin Configuration						Package
BAS 16S	A6s	Q62702-A1241	1=A1	2=A2	3=A3	4=C3	5=C2	6=C1	SOT-363

Maximum Ratings

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	75	V
Peak reverse voltage	V_{RM}	85	
Forward current	I_F	200	mA
Surge forward current, $t = 1 \mu s$	I_{FS}	4.5	A
Total power dissipation, $T_S = 85^\circ C$	P_{tot}	250	mW
Junction temperature	T_j	150	$^\circ C$
Storage temperature	T_{stg}	65 ...+150	

Thermal Resistance

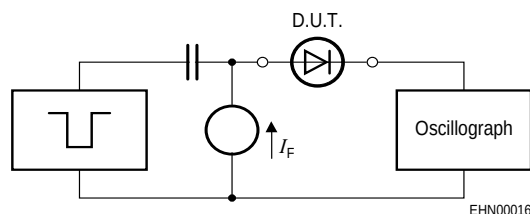
Junction - ambient ¹⁾	R_{thJA}	≤ 530	K/W
Junction - soldering point	R_{thJS}	≤ 260	K/W

1) Package mounted on epoxy pcb 40mm x 40mm x 1.5mm / 0.5cm² Cu

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Breakdown voltage $I_{(BR)} = 100 \mu\text{A}$	$V_{(BR)}$	75	-	-	V
Forward voltage $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 50 \text{ mA}$ $I_F = 150 \text{ mA}$	V_F	- - - -	- - - -	715 855 1000 1250	mV
Reverse current $V_R = 70 \text{ V}$	I_R	-	-	2.5	μA
Reverse current $V_R = 25 \text{ V}, T_A = 150 \text{ }^{\circ}\text{C}$ $V_R = 70 \text{ V}, T_A = 150 \text{ }^{\circ}\text{C}$	I_R	- -	- -	30 50	nA
AC characteristics					
Diode capacitance $V_R = 0 \text{ V}, f = 1 \text{ MHz}$	C_D	-	-	2	pF
Reverse recovery time $I_F = 10 \text{ mA}, I_R = 10 \text{ mA}, R_L = 100 \Omega$, measured at $I_R = 1\text{mA}$	t_{rr}	-	-	6	ns

Test circuit for reverse recovery time

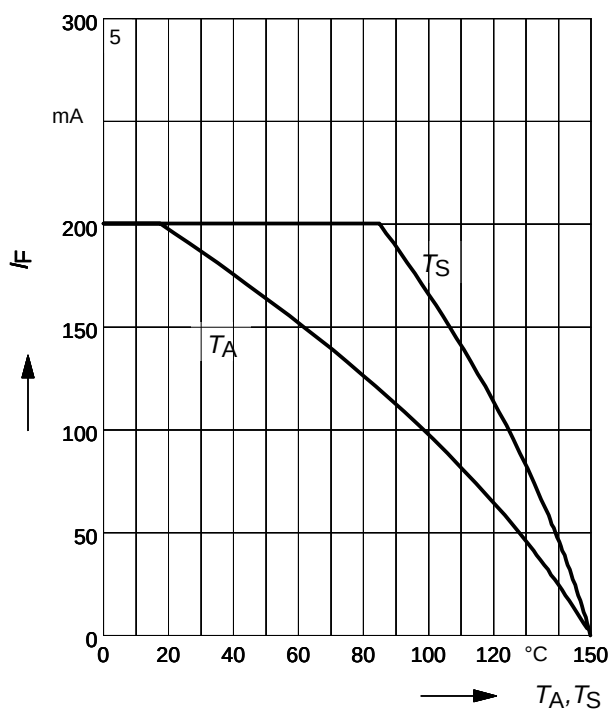


Pulse generator: $t_p = 100 \text{ ns}$, $D = 0.05$,
 $t_r = 0.6 \text{ ns}$, $R_i = 50 \Omega$

Oscilloscope: $R = 50 \Omega$, $t_r = 0.35 \text{ ns}$,
 $C \leq 1 \text{ pF}$

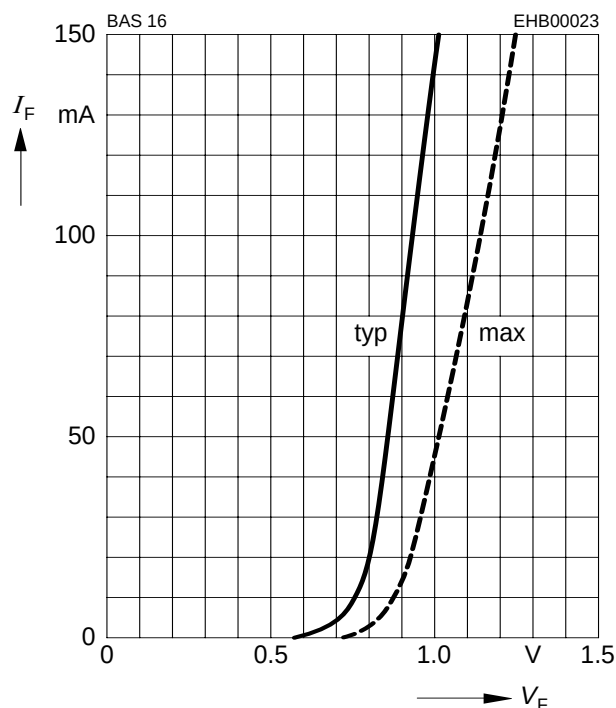
Forward current $I_F = f(T_A^*; T_S)$

* Package mounted on epoxy

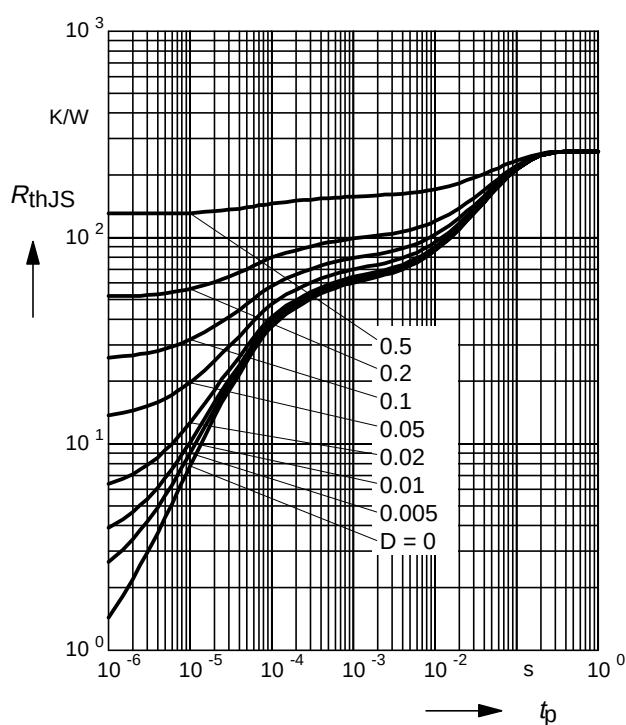


Forward current $I_F = f(V_F)$

$T_A = 25^\circ\text{C}$

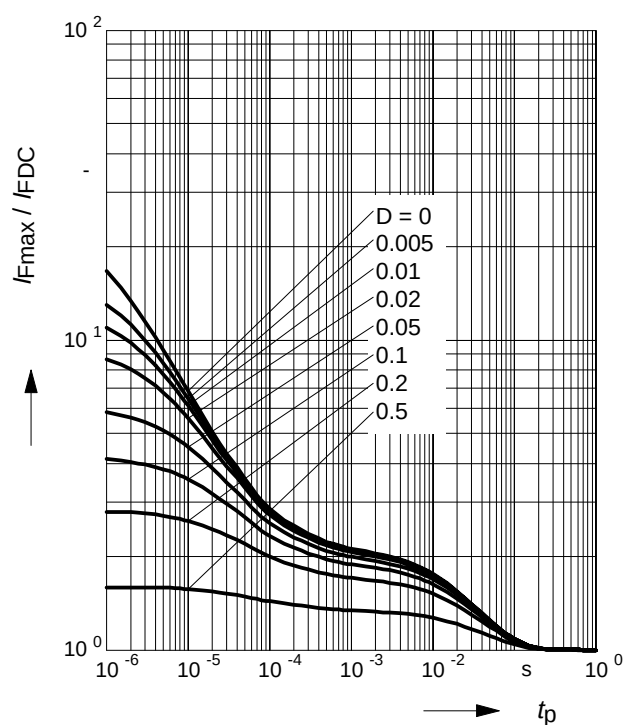


Permissible Pulse Load $R_{thJS} = f(t_p)$

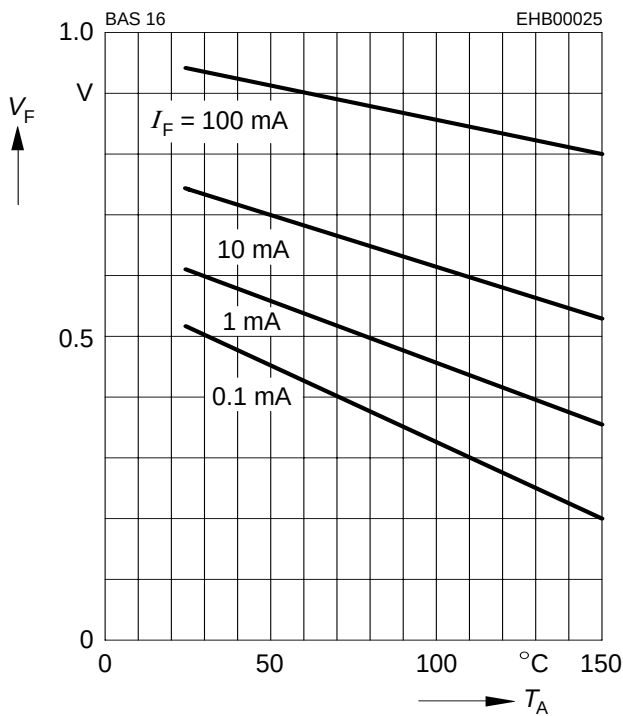


Permissible Pulse Load

$I_{Fmax} / I_{FDC} = f(t_p)$



Forward voltage $V_F = f(T_A)$



Reverse current $I_R = f(T_A)$

